



40V, $10m\Omega$, 10A, Single N-Channel

1.Features

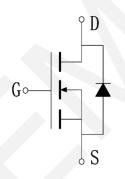
- 40V MOSFET technology
- Low on-state resistance
- Fast switching
- Vgs±20V

2.Applications

- Power Switching Application
- Load Switching



Pin Description



Schematic Diagram

3.Absolute Max Ratings at Ta=25°C (Note1)

Parameter	Symbol	Maximum	Units
Drain to Source Voltage	V _{DSS}	40	V
Gate to Source Voltage	V _{GSS}	±20	V
Drain Current (DC)	Ι _D	10	А
Drain Current (Pulse), PW≤300µs	I _{DP}	120	А
Total Dissipation	PD	1.7	W
Avalanche Energy, Single Pulsed	E _{AS}	64	mJ
Junction Temperature	Tj	150	°C
Storage Temperature	T _{stg}	-55 to +150	°C

Note 1: Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

4. Thermal Resistance Ratings

Parameter	Symbol	Value	Unit
Junction-to-Ambient	$R_{ extsf{ heta}JA}$	31	°C/W

Note 2: When mounted on 1 inch square copper board t \leq 10sec The value in any given application depends on the user's specific board design.



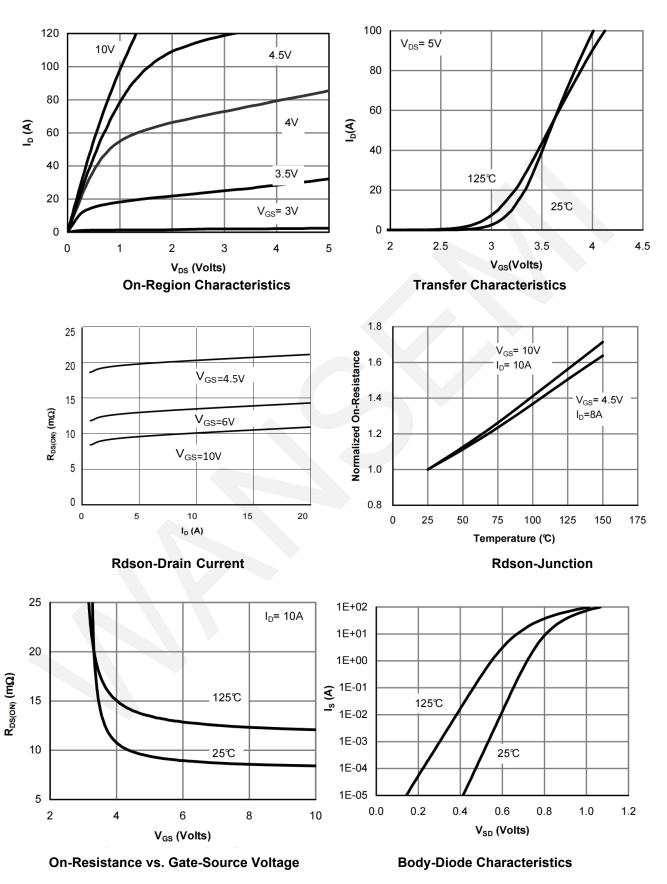
5.Electrical Characteristics at Ta=25°C (Note 3)

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Drain to Source Breakdown Voltage	V _{(BR)DSS}	I _D = 250µA, V _{GS} = 0V	40	45		V
Zero-Gate Voltage Drain Current	I _{DSS}	V_{DS} = 40V, V_{GS} = 0V			1	μA
Gate to Source Leakage Current	I _{GSS}	V_{GS} = ±20V, V_{DS} = 0V			±100	nA
On state drain current	I _{D(ON)}	V _{GS} = 10V, V _{DS} = 5V	120			А
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{DS}=250\mu A$	1	1.6	2.5	V
	R _{DS(on)}	I _D = 10A, V _{GS} = 10V	-	10	13	mΩ
Static Drain to Source On-State Resistance		I _D = 8A, V _{GS} = 6V	-	13	19	mΩ
		I _D = 8A, V _{GS} = 4.5V	-	20		mΩ
Input Capacitance	Ciss	V _{GS} =0V,		1500		pF
Output Capacitance	Coss	V _{DS} =20V,		215		pF
Reverse Transfer Capacitance	Crss	Frequency=1.0MHz		135		pF
Turn-ON Delay Time	t _{d(on)}			6.4		ns
Rise Time	tr	V_{DD} = 20V, R_L = 2 Ω		17		ns
Turn-OFF Delay Time	t _{d(off)}	V_{GS} = 10V, R_G = 3 Ω		30		ns
Fall Time	t _f			16.8		ns
	Qg	V _{DS} = 20V,		27.2		nC
Total Gate Charge	Q _{gs}	V _{GS} = 10V,		4.5		nC
	Q _{gd}	I _D = 10A		6.4		nC
Diode Forward Voltage	V _{FSD}	I _S = 10A, V _{GS} = 0		0.8	1.2	V

Note 3: Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



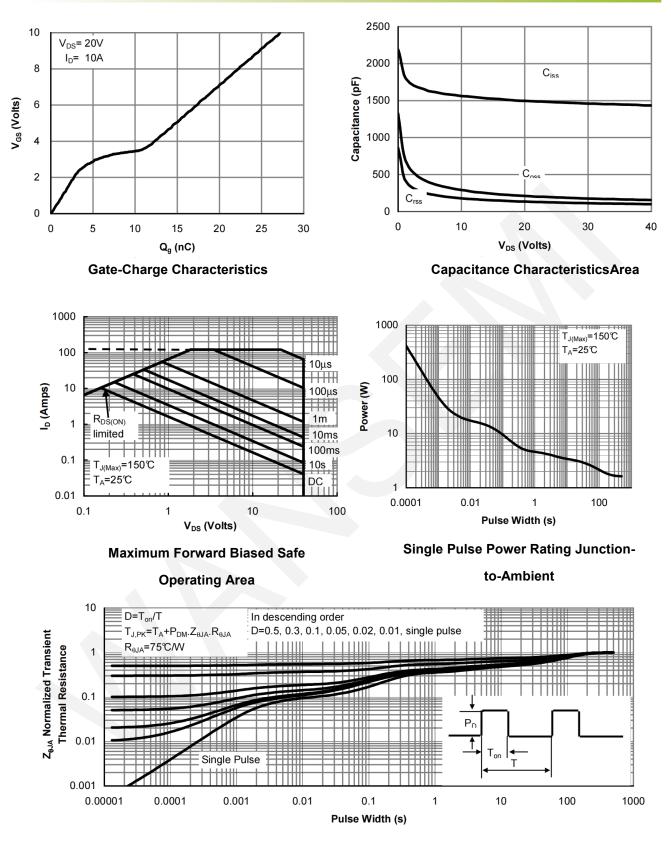




6. Typical electrical and thermal characteristics



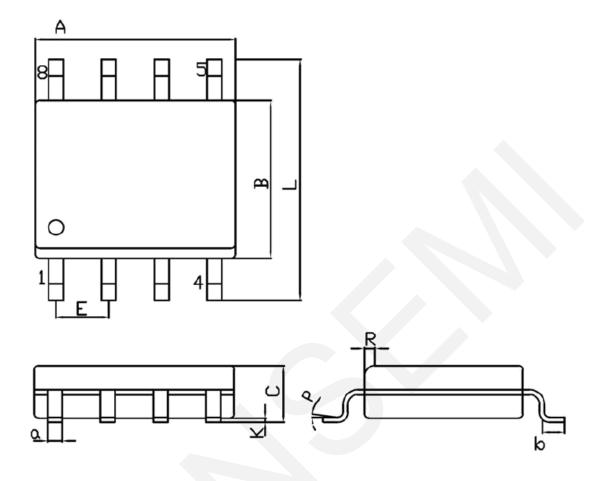
WP4484



Normalized Maximum Transient Thermal Impedance



7.Package Dimensions



Symbol	Dimensions In Millimeters		Symbol	Dimensions In Millimeters		
Symbol	Min	Max	Symbol	Min	Max	
A	4.70	5,10	С	1,35	1.75	
В	3.70	4.10	٩	0.35	0.49	
L	5.80	6.20	R	0.30	0.60	
E	1.27BSC		Р	0*	7*	
ĸ	0.12	0.22	b	0.40	1.25	



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